

Technical Data Sheet

Chip LED with Right Angle

12-21C/R6C-AP1Q2L/2C

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.

Descriptions

- The 12-21C SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Revision

: 1

Device Selection Guide

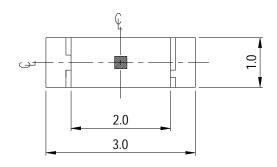
D. AM	Chip	F '44 LG L	Resin Color	
Part No.	Material	Emitted Color		
12-21C/R6C-AP1Q2L/2C	AlGaInP	Brilliant Red	Water Clear	



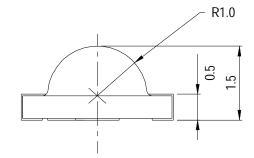
Release Date:2008-09-20 00:16:10.0

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 1 of 10 Device No.: SZDSE-12C-R03 Prepared date: 29-Nov-2007 Prepared by:Liu Meihong

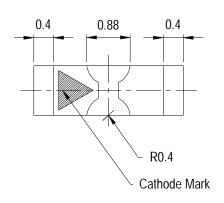
Package Outline Dimensions

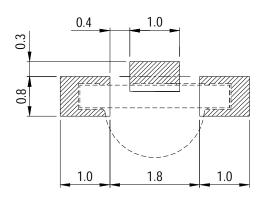






For reflow soldering (propose)





Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

Everlight Electronics Co., Ltd.

Rev.1

Page: 2 of 10

Device No.: SZDSE-12C-R03 Revision : 1

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LifecyclePhase:正式發行

Expired Period: Forever



Absolute Maximum Ratings (Ta=25

Parameter	Symbol	Rating	Unit
Reverse Voltage	V_R	5	V
Forward Current	I_{F}	25	mA
Peak Forward Current (Duty 1/10 @1KHz)	I_{FP}	60	mA
Power Dissipation	P_d	60	mW
Electrostatic Discharge (HBM)	ESD	2000	V
Operating Temperature	Topr	-40 ~ +85	
Storage Temperature	Tstg	-40 ~ +90	
Soldering Temperature	Tsol	Reflow Soldering : 260 Hand Soldering : 350	for 10 sec.

Electro-Optical Characteristics (Ta=25)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	$I_{\rm v}$	45.0	4	112	mcd	A -
Viewing Angle	2 1/2	1	100	1	deg	
Peak Wavelength	p	4	632		nm	
Dominant Wavelength	d	617.5		633.5	nm	I _F =20mA
Spectrum Radiation Bandwidth			20		nm	
Forward Voltage	V_{F}	1.70		2.30	V	
Reverse Current	I_R			10	μA	V _R =5V

Notes:

: 1

Revision

- 1.Tolerance of Luminous Intensity ±11%
- 2.Tolerance of Dominant Wavelength ±1nm
- 3.Tolerance of Forward Voltage ±0.05V

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 3 of 10

Device No.: SZDSE-12C-R03 Prepared date: 29-Nov-2007 Prepared by:Liu Meihong

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Bin Range Of Luminous Intensity

Bin	Min	Max	Unit	Condition	
P1	45.0	57.0			
P2	57.0	72.0	,	I _F =20mA	
Q1	72.0	90.0	mcd		
Q2	90.0	112			

Bin Range Of Dom. Wavelength

Group	Bin	Min	Max	Unit	Condition	
A	E4	617.5	621.5	nm		
	E5	621.5	625.5		I 20 A	
	E6	625.5	629.5		$I_F=20mA$	
	E7	629.5	633.5		-	

Bin Range Of Forward Voltage

Group	Bin	Min	Max	Unit	Condition
	19	1.70	1.80		
	20	1.80	1.90	11-	
T	21	1.90	2.00	V	I 20 A
L	22	2.00	2.10	V	I _F =20mA
	23	2.10	2.20		
- A	24	2.20	2.30		

Notes:

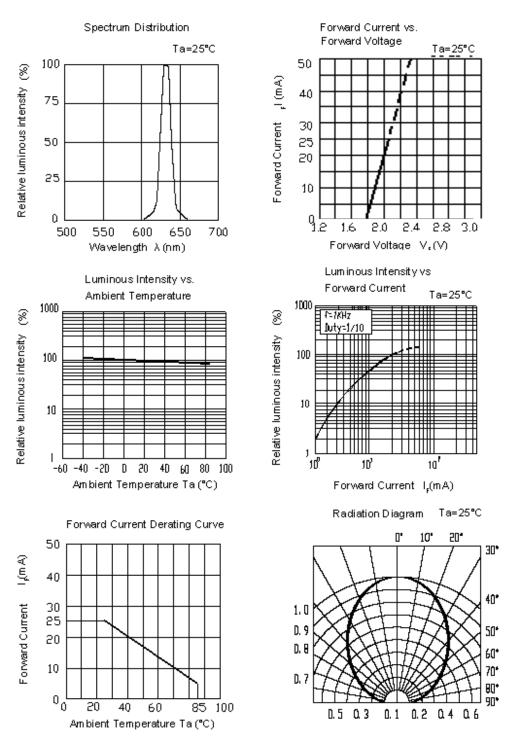
- 1.Tolerance of Luminous Intensity ±11%
- 2. Tolerance of Dominant Wavelength ±1nm
- 3.Tolerance of Forward Voltage ±0.05V

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 4 of 10

Device No.: SZDSE-12C-R03 Prepared date: 29-Nov-2007 Prepared by:Liu Meihong

Revision: 1 Release Date: 2008-09-20 00:16:10.0

Typical Electro-Optical Characteristics Curves



Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 5 of 10

Device No.: SZDSE-12C-R03 Prepared date: 29-Nov-2007 Prepared by:Liu Meihong

Release Date:2008-09-20 00:16:10.0

LifecyclePhase:正式發行 Expired Period: Forever

Revision

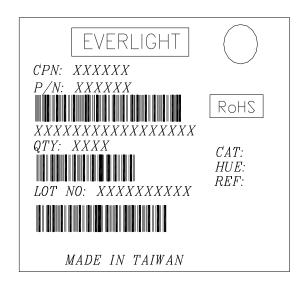
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Label explanation

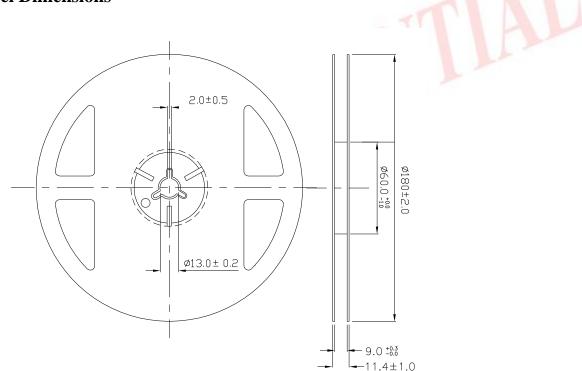
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

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Device No.: SZDSE-12C-R03

Revision: 1

LifecyclePhase:正式發行

http://www.everlight.com

Rev.1

Page: 6 of 10

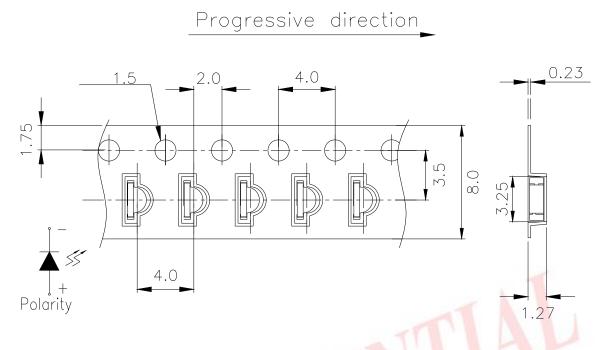
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7 Prepared by:Liu Meihong Release Date:2008-09-20 00:16:10.0

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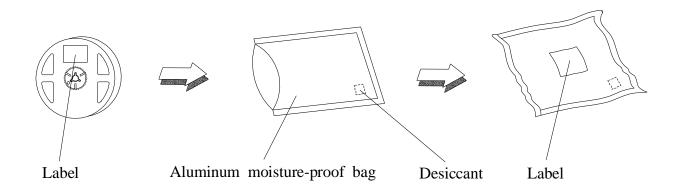


Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



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: 1

Revision

Device No.: SZDSE-12C-R03 Prepared date: 29-Nov-2007

7 Prepared by:Liu Meihong Release Date:2008-09-20 00:16:10.0

Page: 7 of 10

Rev.1



Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp.: 260 ±5 Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H: +100 15min 5 min L: -40 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H: +100 5min 10 sec L: -10 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp.: 100	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85 / 85%RH	1000 Hrs.	22 PCS.	0/1

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Device No.: SZDSE-12C-R03 Prepared date: 29-Nov-2007 Prepared by:Liu Meihong

Revision: 1 Release Date: 2008-09-20 00:16:10.0

Precautions For Use

1. Over-current-proof

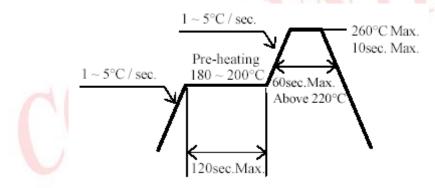
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30 or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30 or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.Baking treatment: 60±5 for 24 hours.
- 3. Soldering Condition

Revision

: 1

3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 9 of 10

Device No.: SZDSE-12C-R03 Prepared date: 29-Nov-2007 Prepared by:Liu Meihong

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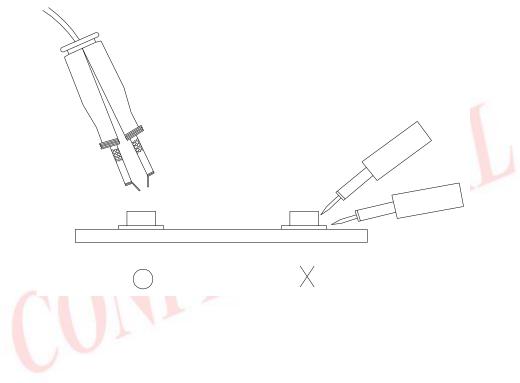


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350 for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 10 of 10

Device No.: SZDSE-12C-R03 Prepared date: 29-Nov-2007 Prepared by:Liu Meihong

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